

Parameter	Rating	Units		
Blocking Voltage	800	V <sub>P</sub>		
Load Current				
AC/DC Configuration	100	mA <sub>rms</sub> / mA <sub>DC</sub>		
DC Configuration	180	mA <sub>DC</sub>		
On-Resistance (max)				
AC/DC Configuration	50	0		
DC Configuration	14	22		

#### **Features**

- 800V<sub>P</sub> Blocking Voltage
- 3750V<sub>rms</sub> Input/Output Isolation
- 100% Solid State
- Low Drive Power Requirements
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 6-Pin Package
- Flammability Rating UL 94 V-0

# **Applications**

- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

# **Description**

PLA170 is a single-pole, normally open (1-Form-A) Solid State Relay that uses optically coupled MOSFET technology to provide an enhanced input-to-output isolation of  $3750V_{\rm rms}$ .

Its optically coupled outputs, which use the patented OptoMOS architecture, are controlled by a highly efficient infrared LED.

Designed to replace electromechanical relays, the PLA170 offers the superior reliability associated with solid state devices, and provides bounce-free switching in a more compact surface mount or thru-hole package.

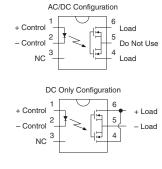
#### **Approvals**

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: Certificate available on our website

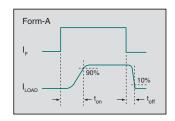
# **Ordering Information**

Part #	Description
PLA170	6-Pin DIP (50/tube)
PLA170S	6-Pin Surface Mount (50/tube)
PLA170STR	6-Pin Surface Mount (1000/Reel)

# **Pin Configuration**



#### Switching Characteristics of Normally Open Devices











# Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	800	$V_{P}$
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	Α
Input Power Dissipation <sup>1</sup>	150	mW
Total Power Dissipation <sup>2</sup>	800	mW
Isolation Voltage, Input to Output	3750	V <sub>rms</sub>
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

<sup>1</sup> Derate linearly 1.33 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

# Electrical Characteristcs @ 25°C

Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics						
Load Current, Continuous						
AC/DC Configuration <sup>1</sup>		I <sub>L</sub> -		-	100	mA <sub>rms</sub> / mA <sub>DC</sub>
DC Configuration	-		-		180	mA <sub>DC</sub>
Peak Load Current	t=10ms	I <sub>LPK</sub>	-	-	±350	mA <sub>P</sub>
On-Resistance <sup>2</sup>						
AC/DC Configuration	L Lood Current	D	-	-	50	Ω
DC Configuration	I <sub>L</sub> =Load Current	R <sub>ON</sub>	-	-	14	22
Off-State Leakage Current	V <sub>L</sub> =800V <sub>P</sub>	I <sub>LEAK</sub>	-	-	1	μΑ
Switching Speeds						
Turn-On	I 5 1 1/ 10\/	t <sub>on</sub>	-	-	5	ms
Turn-Off	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>off</sub>	-	-	5	1115
Output Capacitance	I <sub>F</sub> =0mA, V <sub>L</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	50	-	pF
Input Characteristics						
Input Control Current to Activate <sup>3</sup>	I <sub>L</sub> =Load Current	I <sub>F</sub>	-	-	5	mA
Input Control Current to Deactivate	-	I <sub>F</sub>	0.3	0.7	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.5	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μΑ
Common Characteristics						
Input to Output Capacitance	V <sub>IO</sub> =0V, f=1MHz	C <sub>IO</sub>	-	3	-	pF

<sup>&</sup>lt;sup>1</sup> Load derates linearly from 100mA @ 25°C to 90mA @80°C.

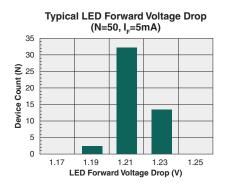
<sup>&</sup>lt;sup>2</sup> Derate linearly 6.67 mW / °C

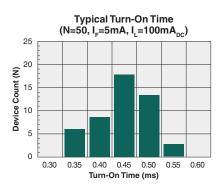
<sup>&</sup>lt;sup>2</sup> Measurement taken within 1 second of on-time.

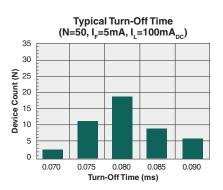
<sup>&</sup>lt;sup>3</sup> For applications requiring high temperature operation (greater than 60°C) a minimum LED drive current of 10mA is recommended.

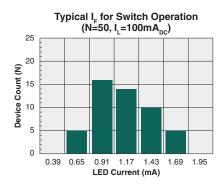


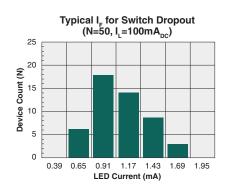
#### **PERFORMANCE DATA\***

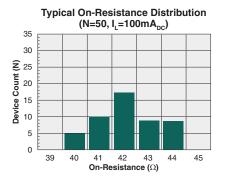


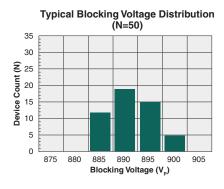


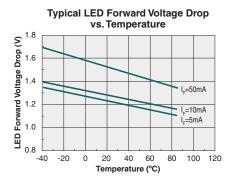


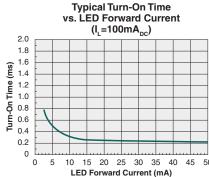


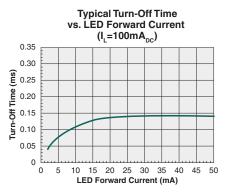








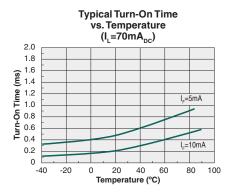


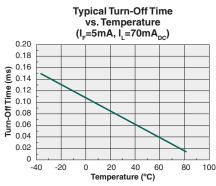


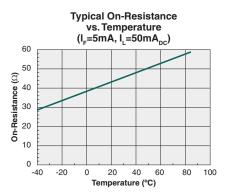
\*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.

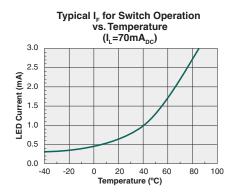


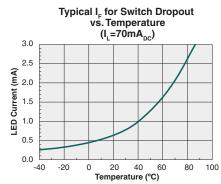
#### **PERFORMANCE DATA\***

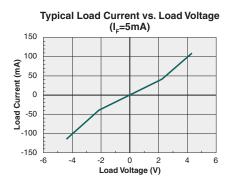


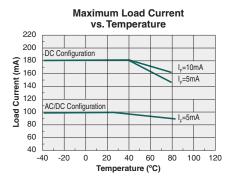


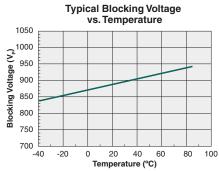


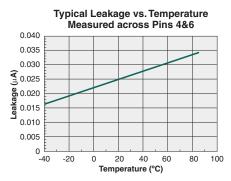


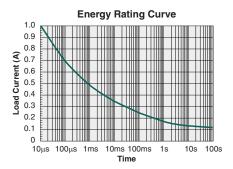












\*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.



# **Manufacturing Information**

# **Moisture Sensitivity**

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
PLA170 / PLA170S	MSL 1

#### **ESD Sensitivity**



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

# **Soldering Profile**

Provided in the table below is the Classification Temperature ( $T_C$ ) of this product and the maximum dwell time the body temperature of this device may be ( $T_C$  - 5)°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

Device	Classification Temperature (T <sub>c</sub> )	Dwell Time (t <sub>p</sub> )	Max Reflow Cycles
PLA170	250°C	30 seconds	1
PLA170S	250°C	30 seconds	3

#### **Board Wash**

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.



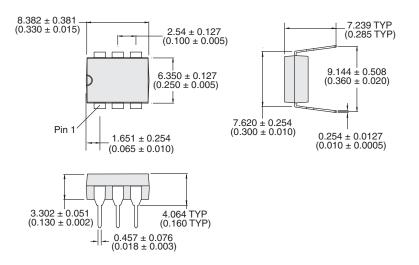




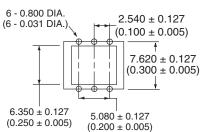


#### **Mechanical Dimensions**

# **PLA170**

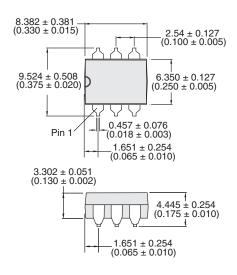


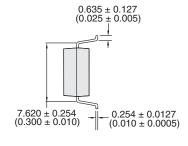
#### **PCB Hole Pattern**



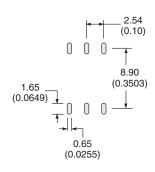
Dimensions mm (inches)

# **PLA170S**





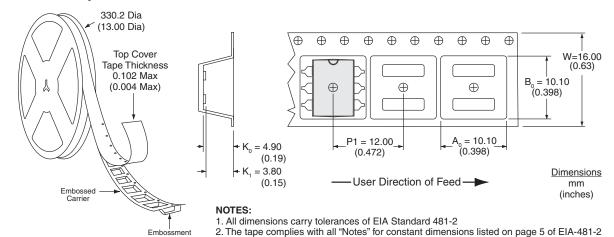
#### **PCB Land Pattern**



Dimensions mm (inches)



# PLA170STR Tape & Reel



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